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DOCKET NO. 01-0086 (STMI01-01086)  
Customer No. 30425

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of : DANIELLE A. THOMAS, ET AL.  
U.S. Serial No. : 10/091,743  
Filed : March 6, 2002  
For : SYSTEM AND METHOD FOR PROVIDING A REDISTRIBUTION  
METAL LAYER IN AN INTEGRATED CIRCUIT  
Group No. : 3729  
Examiner : Donghai D. Nguyen

**MAIL STOP AF**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

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Sir:

The undersigned hereby certifies that the following documents:

1. Amendment and Response Under 37 C.F.R. §1.116; and
2. Postcard Receipt

relating to the above application, were deposited as "First Class Mail" with the United States Postal Service, addressed to MAIL STOP AF, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on December 29, 2004.

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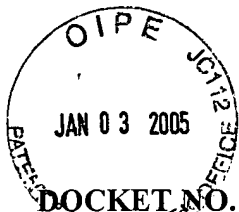
Dec. 29 2004

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**DOCKET NO. 01-C-086 (STMI01-01086)**  
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Sirs:

**AMENDMENT AND RESPONSE UNDER 37 C.F.R. §1.116**

In response to the Office Action dated October 29, 2004, please amend the above-identified patent application as follows.